

2SC4262

Silicon NPN Epitaxial

REJ03G0720-0300 (Previous ADE-208-1100A) Rev.3.00 Aug.10.2005

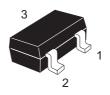
Application

UHF / VHF Local oscillator

Outline

RENESAS Package code: PTSP0003ZA-A

(Package name: ČMPAK®)



1. Emitter

2. Base

3. Collector

Note: Marking is "IP-".

*CMPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

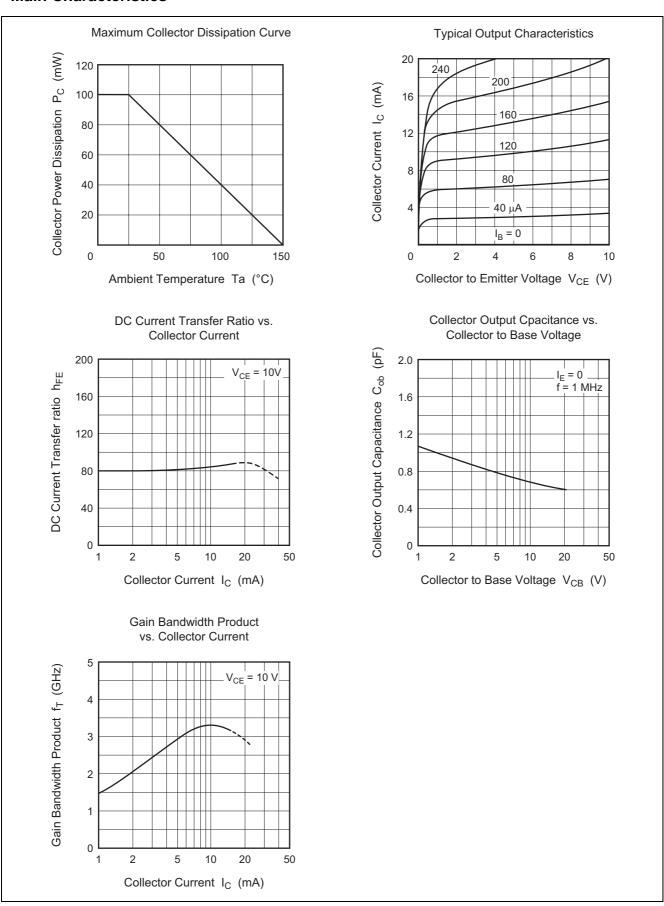
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	20	V
Collector to emitter voltage	V _{CEO}	15	V
Emitter to base voltage	V _{EBO}	3	V
Collector current	Ic	50	mA
Collector power dissipation	P _C	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Electrical Characteristics

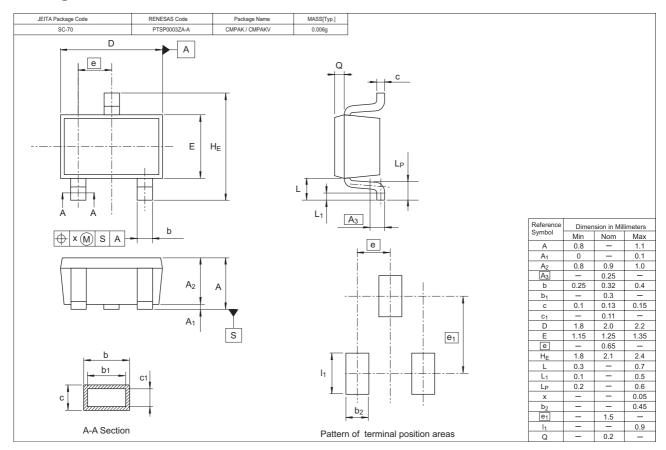
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	20	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	15	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Collector cutoff current	I _{CBO}	_	_	0.5	μΑ	$V_{CB} = 15 \text{ V}, I_E = 0$
Emitter cutoff current	I _{EBO}	_	_	1.0	μΑ	$V_{EB} = 3 \text{ V}, I_{C} = 0$
Collector to emitter saturation voltage	V _{CE(sat)}	_	_	0.5	V	$I_C = 20 \text{ mA}, I_B = 4 \text{ mA}$
DC current transfer ratio	h _{FE}	50	_	200		$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$
Collector output capacitance	Cob	_	_	1.0	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1MHz$
Gain bandwidth product	f⊤	1.4	2.9	_	GHz	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$

Main Characteristics



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC4262IP-TL-E	3000	φ 178 mm Reel, 8 mm Emboss Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd. Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510